

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Shi-Wen CHEN</td> <td>09/25/2012</td> </tr> <tr> <td>Hsin-Pang LU</td> <td>09/25/2012</td> </tr> <tr> <td>Chung-Cheng TSAI</td> <td>09/25/2012</td> </tr> <tr> <td>Ya-Nan MOU</td> <td>09/25/2012</td> </tr> </tbody> </table>		Name	Execution Date	Shi-Wen CHEN	09/25/2012	Hsin-Pang LU	09/25/2012	Chung-Cheng TSAI	09/25/2012	Ya-Nan MOU	09/25/2012
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<table border="1"> <tr> <td>Name:</td> <td>UNITED MICROELECTRONICS CORP.</td> </tr> <tr> <td>Street Address:</td> <td>NO. 3, LI-HSIN RD. II</td> </tr> <tr> <td>Internal Address:</td> <td>SCIENCE-BASED INDUSTRIAL PARK</td> </tr> <tr> <td>City:</td> <td>HSINCHU</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	UNITED MICROELECTRONICS CORP.	Street Address:	NO. 3, LI-HSIN RD. II	Internal Address:	SCIENCE-BASED INDUSTRIAL PARK	City:	HSINCHU	State/Country:	TAIWAN
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CORRESPONDENCE DATA											
<p>Fax Number: 530685979  <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 2816688988        Email: dean.foresight@gmail.com        Correspondent Name: FORESIGHT IP DING YU TAN        Address Line 1: 14F., No.111, Songjiang Rd        Address Line 2: Unit B03        Address Line 4: Taipei, TAIWAN</p>											
ATTORNEY DOCKET NUMBER:	10585UMC-US										
NAME OF SUBMITTER:	Ding Yu Tan										
	This document serves as an Oath/Declaration (37 CFR 1.63).										
<p>Total Attachments: 3        source=10585UMC_US_DA#page1.tif        source=10585UMC_US_DA#page2.tif        source=10585UMC_US_DA#page3.tif</p>											

OP \$40.00 13652422

PATENT

**Declaration (37 CFR 1.63) for Utility Patent Application Using An  
Application Data Sheet (37 CFR 1.76) and  
Assignment For Single Assignee**

The title of the invention is as follow:

MEMORY, SUPPLY VOLTAGE GENERATION CIRCUIT, AND OPERATION METHOD  
OF A SUPPLY VOLTAGE GENERATION CIRCUIT USED FOR A MEMORY ARRAY

As a below named inventor, I hereby declare that this declaration is directed to the application of which is attached hereto unless the following box is checked:

☐ was filed on \_\_\_\_\_ as United States Application Number or PCT International Application Number \_\_\_\_\_

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, United Microelectronics Corporation (hereinafter referred to "Assignee") whose mailing address is NO. 3, LI-HSIN RD. II, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU, TAIWAN is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

Now, therefore, in consideration of the sum of One dollars (\$ 1.00), the receipt whereof is acknowledged, and for other good and valuable consideration, I, by these presents hereby do sell, assign and transfer unto said Assignee the entire right, title, and interest in and to any and all improvements which are disclosed in said invention and, in and to, all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all continuations, continuation-in-part, divisions, renewals, substitutions, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Assignee as the assignee of my entire right, title and interest in and to the same, for the sole use and behoof of said Assignee, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.

Further, I agree that I will communicate to said Assignee or its (his) representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Assignee, make all rightful oaths, and, generally do everything possible to aid said Assignee, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

Direct all Correspondence to:

**The Address Associated with Customer Number 66749**

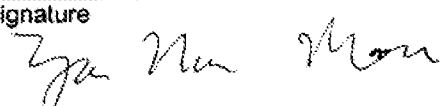
Legal Name of Sole or First Inventor: Shi-Wen CHEN	
Inventor's signature <i>Shi-Wen CHEN</i>	Date SEP 25 2012

Legal Name of Additional Joint Inventor, if any: Hsin-Pang LU	
Inventor's signature <i>Hsin-Pang Lu</i>	Date SEP 25 2012

Legal Name of Additional Joint Inventor, if any: Chung-Cheng TSAI	
Inventor's signature <i>Chung-cheng, Tsai</i>	Date SEP 25 2012

☒ Additional inventors are being named on the next page, if any

UMCD-2012-0160

Legal Name of Additional Joint Inventor, if any: Ya-Nan MOU	
Inventor's signature 	Date SEP 25 2012

☐ Additional inventors are being named on the next page, if any